



DMT67M8LCG

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C
60V	5.7mΩ @ V <sub>GS</sub> = 10V	64.6A
	8.1mΩ @ V <sub>GS</sub> = 4.5V	54.2A

# **Description and Applications**

This new generation N-channel enhancement mode MOSFET is designed to minimize R<sub>DS(ON)</sub> and yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and load switch.

- Synchronous Rectifier
- **Power Management Functions**
- **DC-DC** Converters

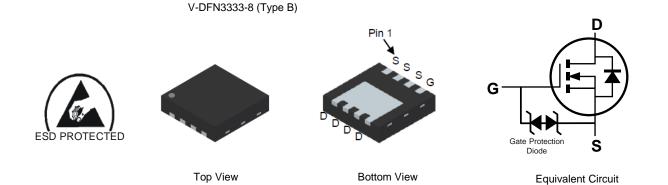
#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Features and Benefits**

- 100% Unclamped Inductive Switching (UIS) Test in Production -. Ensures More Reliable And Robust End Application
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: V-DFN3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Below Diagram
- Terminals: Finish-NiPdAu over Copper Leadframe.
- Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.027 grams (Approximate)



### Ordering Information (Note 4)

	Part Number	Case	Packaging			
	DMT67M8LCG-7	V-DFN3333-8 (Type B)	2,000/Tape & Reel			
	DMT67M8LCG-13	V-DFN3333-8 (Type B)	3,000/Tape & Reel			
Notes:	lotes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



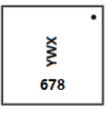
# **Marking Information**

Site1:



678 = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 19 = 2019) WW = Week (01 to 53)

Site2:



678 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 9 = 2019) W = Week (ex: a = week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2017	2018	2019	2020	2021	2022	2023	2024	2025	
Code	7	8	9	0	1	2	3	4	5	
Week	1-26			27-52				53		
Code	A-Z			a-z				Z		
Internal Code	Sun	Mor	า	Tue	Wed	Thu		Fri	Sat	
Code	Т	U		V	W	Х		Y	Z	



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	16 12.8	А
Continuous Drain Current, $V_{GS} = 10V$ (Note 7) $T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$		ID	64.6 51.7	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	256	A
Maximum Continuous Body Diode Forward Current (Note	e 6)	ls	64	A
Pulsed Body Diode Forward Current (10µs Pulse, Duty C	I <sub>SM</sub>	256	A	
Avalanche Current, L=0.3mH	I <sub>AS</sub>	23.7	A	
Avalanche Energy, L=0.3mH	E <sub>AS</sub>	84.5	mJ	

#### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)		R <sub>θJA</sub>	138	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{\theta JA}$	57	°C/W
Thermal Resistance, Junction to Case (Note 7)		R <sub>0</sub> JC	3.5	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

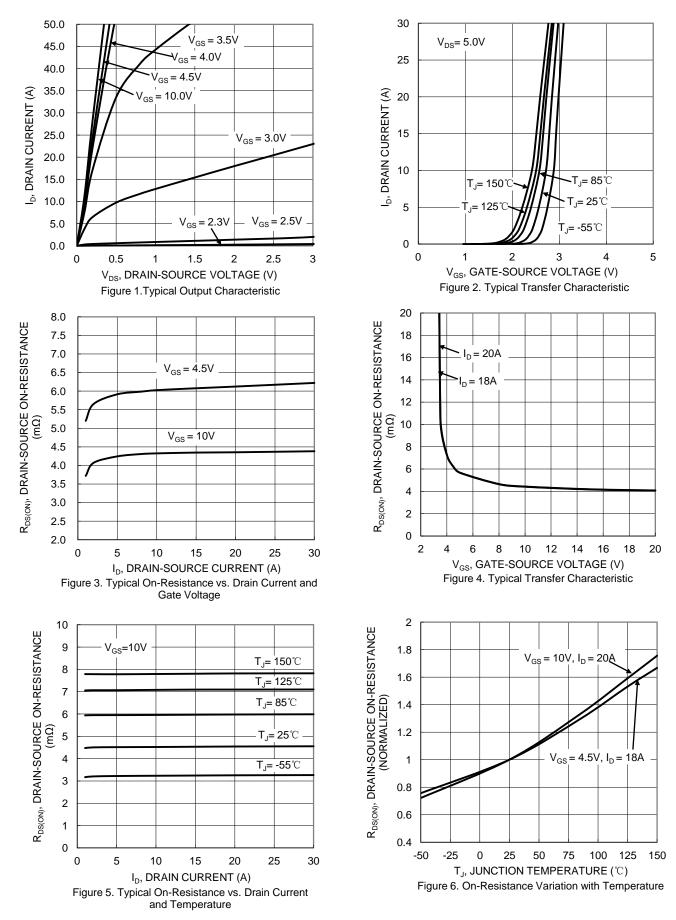
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	Cyniser		.,,,,	Шах	Unit	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—	—	V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.2		2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
Static Drain-Source On-Resistance		—	4.3	5.7	mΩ	$V_{GS} = 10V, I_D = 20A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	6.1	8.1	1112	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 18A
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 13.5A
DYNAMIC CHARACTERISTICS (Note 9)	•		•			·
Input Capacitance	Ciss	—	2130	—		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz
Output Capacitance	Coss	—	786	_	pF	
Reverse Transfer Capacitance	Crss	—	70	—		
Gate Resistance	Rg	—	0.6	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	—	20	—		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	—	37.5	—	nC	$V_{DS} = 30V, I_{D} = 20A$
Gate-Source Charge	Q <sub>gs</sub>	_	5.4	_	nc	$v_{\rm DS} = 30 v,  i_{\rm D} = 20 A$
Gate-Drain Charge	Q <sub>gd</sub>	_	9.5	—		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5.5	—		
Turn-On Rise Time	t <sub>R</sub>	_	6.8	_		$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>		22.1		ns	$I_D = 20A, R_G = 3\Omega$
Turn-Off Fall Time	t <sub>F</sub>		10.8			
Reverse Recovery Time	t <sub>RR</sub>		26.9		ns	
Reverse Recovery Charge	Q <sub>RR</sub>	—	56.8	—	nC	−I <sub>F</sub> = 20A, di/dt = 300A/μs

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.
Overstand background the standard transformation of the standard transformation of the standard transformation. Notes:

9. Guaranteed by design. Not subject to product testing.



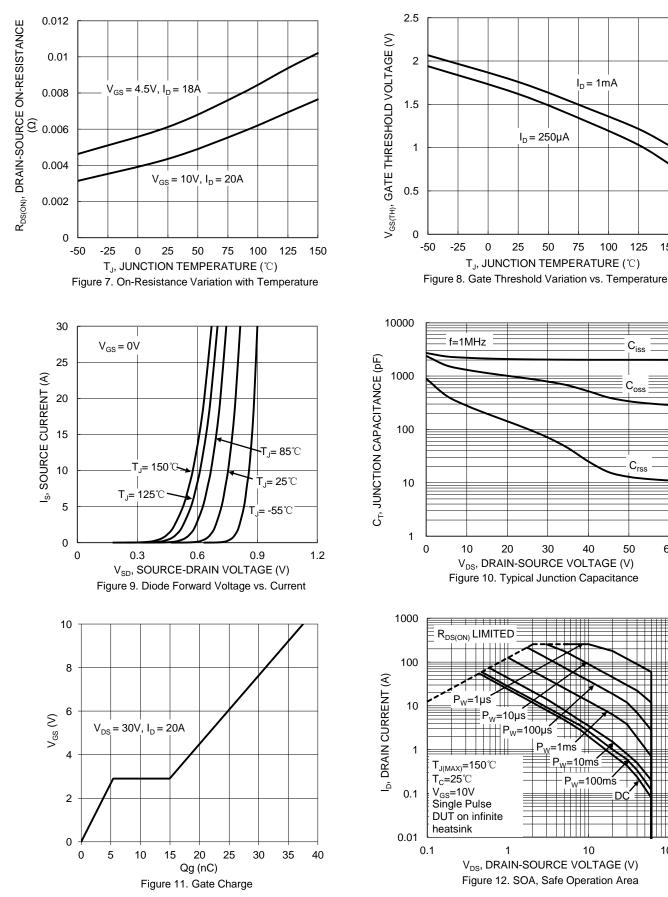




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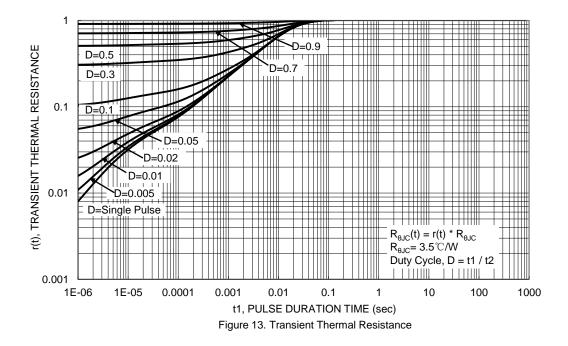
150

60



100

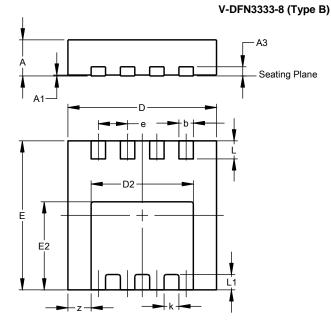






### **Package Outline Dimensions**

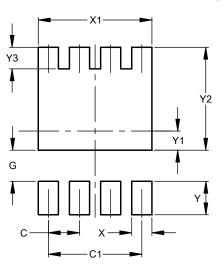
Please see http://www.diodes.com/package-outlines.html for the latest version.



	V-DFN3333-8							
(Туре В)								
Dim	Min	Max	Тур					
Α	0.75	0.85	0.80					
A1	0.00	0.05	0.02					
A3			0.203					
b	0.27	0.37	0.32					
D	3.25	3.35	3.30					
D2	2.17	2.37	2.27					
Е	3.25	3.35	3.30					
E2	1.85	2.05	1.95					
е	-		0.65					
k			0.33					
L	0.35	0.45	0.40					
L1			0.34					
z			0.515					
All	All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



#### V-DFN3333-8 (Type B)

Dimensions	Value (in mm)
С	0.650
C1	1.950
G	0.650
Х	0.420
X1	2.370
Y	0.700
Y1	0.400
Y2	2.150
Y3	0.450



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